# 2SD1330

## Silicon NPN epitaxial planar type

For low-voltage output amplification

For muting

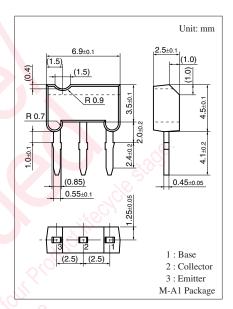
For DC-DC converter

#### ■ Features

- ullet Low collector-emitter saturation voltage  $V_{CE(sat)}$
- Low ON resistance Ron
- High forward current transfer ratio h<sub>FE</sub>
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	$V_{CBO}$	25	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V	
Emitter-base voltage (Collector open)	$V_{EBO}$	12	V	
Collector current	$I_{\rm C}$	0.5	A	
Peak collector current	I <sub>CP</sub>	1	A	
Collector power dissipation	P <sub>C</sub>	600	mW	
Junction temperature	T <sub>j</sub>	150	°CO	
Storage temperature	$T_{stg}$	-55 to +150	°C	



## ■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 10 \mu\text{A}, I_E = 0$	25	, ele	*	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 1 \text{ mA}, I_B = 0$	20	20,		V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10  \mu A, I_C = 0$	12	0		V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 25 \text{ V}, I_{E} = 0$	1.00		100	nA
Forward current transfer ratio *1	h <sub>FE1</sub> *2	$V_{CE} = 2 \text{ V}, I_{C} = 0.5 \text{ A}$	200		800	_
	h <sub>FE2</sub>	$V_{CE} = 2 \text{ V}, I_{C} = 1 \text{ A}$	60			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 0.5 \text{ A}, I_B = 20 \text{ mA}$		0.13	0.4	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_C = 0.5 \text{ A}, I_B = 50 \text{ mA}$			1.2	V
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		10		pF
(Common base, input open circuited)		Q 15 1				
ON resistanse *3	R <sub>on</sub>			1		Ω

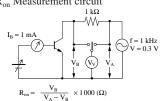
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

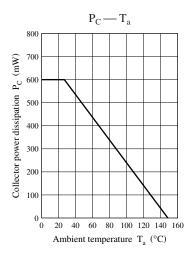
### 2. \*1: Pulse measurement

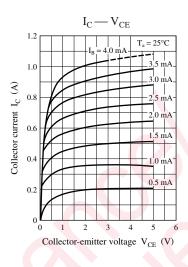
#### \*2: Rank classification

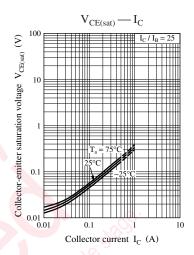
Rank	R	S	Т
h <sub>FE1</sub>	200 to 350	300 to 500	400 to 800

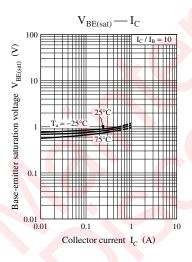
### \*3: R<sub>on</sub> Measurement circuit

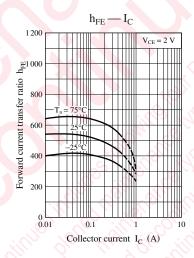


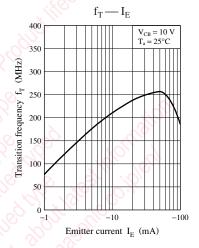


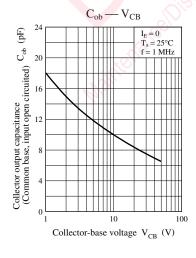


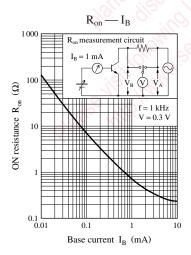












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